

### **FUJI POWER MOSFET**

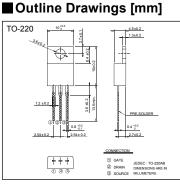
# **Super J-MOS series**

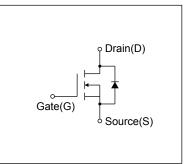
# N-Channel enhancement mode power MOSFET

Features
Low on-state resistance
Low switching loss
easy to use (more controllabe switching dV/dt by Rg)

# Applications

UPS Server Telecom Power conditioner system Power supply





Equivalent circuit schematic

## Absolute Maximum Ratings at TC=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Durain Courses Vialde no	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V <sub>GS</sub> =-30V
Continuous Drain Current		±8	А	Tc=25°C Note*1
Continuous Drain Current	ID	±5.1	А	Tc=100°C Note*1
Pulsed Drain Current	IDP	±24	А	
Gate-Source Voltage	V <sub>gs</sub>	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	2.5	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	249.6	mJ	Note *3
Maximum Drain-Source dV/dt	dV₀s/dt	50	kV/µs	V <sub>DS</sub> ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	15	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
Maximum Dawar Disaination	Po	2.02	14/	T₂=25°C
Maximum Power Dissipation		70	W	Tc=25°C
Operating and Starage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	Tstg	-55 to +150	°C	

Note \*1 : Limited by maximum channel temperature.

 Note \*2: Teh≤150°C, See Fig.1 and Fig.2

 Note \*3: Starting Teh=25°C, IAs=1.5A, L=203mH, Vob=60V, Re=50Ω, See Fig.1 and Fig.2

 EAs limited by maximum channel temperature and avalanche current.

 Note \*4: Irs=1-0, -di/dt=100A/lys, Vob≤400V, Vpeak≤BVbss, Teh≤150°C.

 Note \*5: Irs=10, di/dt=15kV/µs, Vob≤400V, Vpeak≤BVbss, Teh≤150°C.

#### Electrical Characteristics at TC=25°C (unless otherwise specified) Dynamic Ratings

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA V <sub>GS</sub> =0V		600	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =250µA V <sub>DS</sub> =V <sub>GS</sub>		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> =600V V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	25	-μA
		V <sub>DS</sub> =480V V <sub>GS</sub> =0V	T <sub>ch</sub> =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V <sub>GS</sub> = ± 30V V <sub>DS</sub> =0V	·	-	10	100	nA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	I₀=4A V₀s=10V		-	0.399	0.47	Ω
Gate resistance	RG	f=1MHz, open drain		-	2.9	-	Ω

# Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	<b>g</b> fs	I <sub>D</sub> =4A V <sub>DS</sub> =25V	3.5	7.5	-	S
Input Capacitance	Ciss	V <sub>DS</sub> =10V	-	620	-	
Output Capacitance	Coss	V <sub>GS</sub> =0V	-	1340	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	120	-	
Effective output capacitance, energy related (Note *6)	C <sub>o(er)</sub>	V <sub>GS</sub> =0V V <sub>DS</sub> =0480V	-	48	-	pF
Effective output capacitance, time related (Note *7)	C <sub>o(tr)</sub>	V <sub>cs</sub> =0V V <sub>bs</sub> =0480V ID=constant	-	140	-	
	t <sub>d(on)</sub>		-	9.5	-	
Turn-On Time	tr	V <sub>DD</sub> =400V, V <sub>GS</sub> =10V/0V	-	29	-	
Turne Off Times	t <sub>d(off)</sub>	I₀=4A, R₀=30Ω See Fig.3 and Fig.4	-	75	-	ns
Turn-Off Time	tr		-	16	-	
Total Gate Charge	QG		-	25	-	
Gate-Source Charge	Q <sub>GS</sub>	V₀₀=480V, l₀=8A − V₀₅=10V _ See Fig.5	-	7.5	-	
Gate-Drain Charge	QGD		-	6	-	nC
Drain-Source crossover Charge	Qsw		-	5	-	1

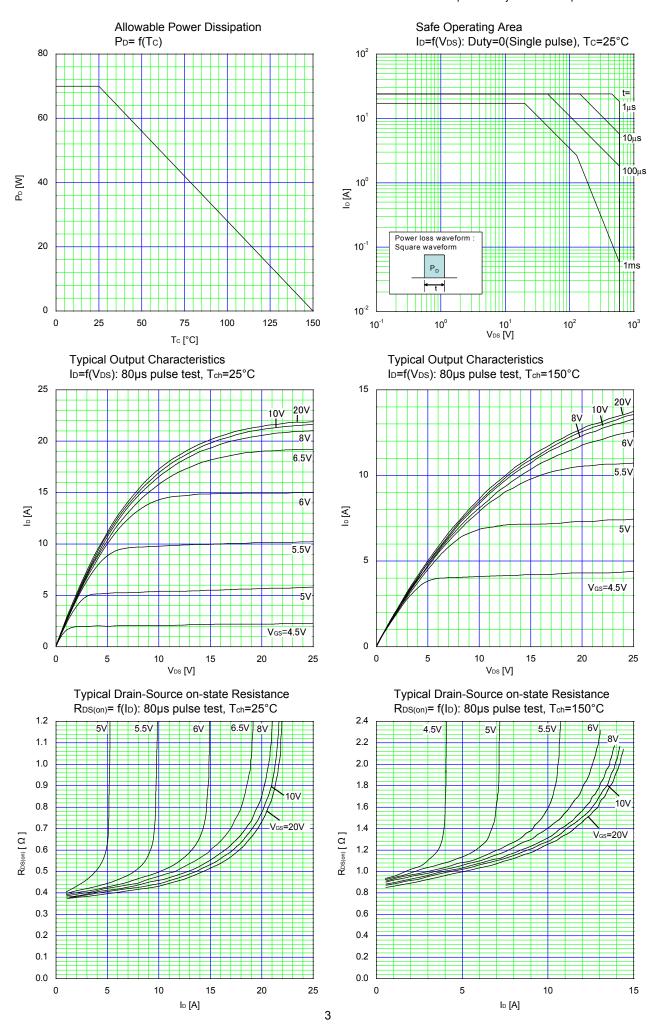
Note \*6 :  $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{Ds}$  is rising from 0 to 80% BV<sub>Dss</sub>. Note \*7 :  $C_{o(tr)}$  is a fixed capacitance that gives the same charging times as  $C_{oss}$  while  $V_{Ds}$  is rising from 0 to 80% BV<sub>Dss</sub>.

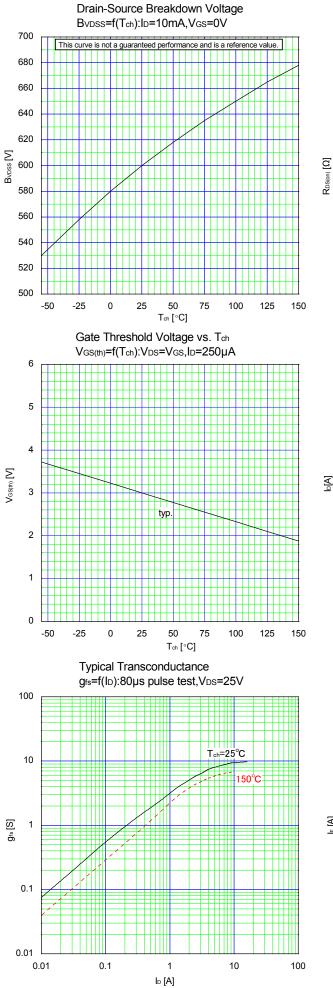
#### Reverse Diode

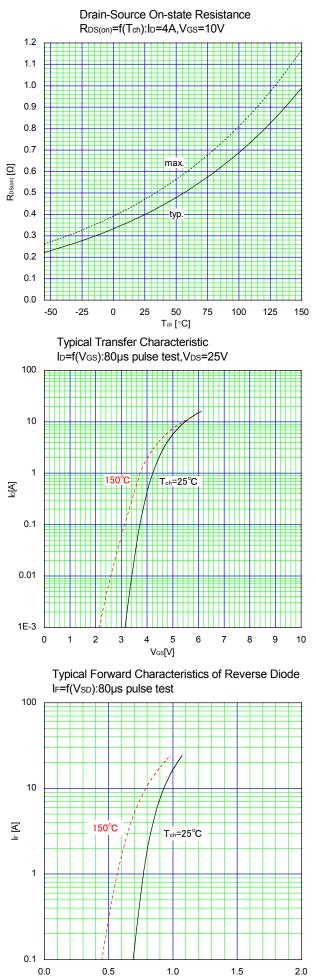
Description	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=43.9mH, T₀₀=25°C See Fig.1 and Fig.2	2.5	-	-	А
Diode Forward On-Voltage	Vsd	I <sub>F</sub> =8A, V <sub>GS</sub> =0V T <sub>ch</sub> =25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	$I_{\text{F}}=8A, V_{\text{DD}}=400V \\ -di/dt=100A/\mu s \\ V_{\text{GS}(01)}=short, V_{\text{GS}(02)}=10V/0V \\ R_{\text{G}}=330\Omega \\ T_{\text{ch}}=25^{\circ}C \\ See \ Fig.6 \ and \ Fig.7 \\ \end{bmatrix}$		285	-	ns
Reverse Recovery Charge	Qrr		-	3.2	-	μC
Peak Reverse Recovery Current	Irp		-	20	-	А

# Thermal Resistance

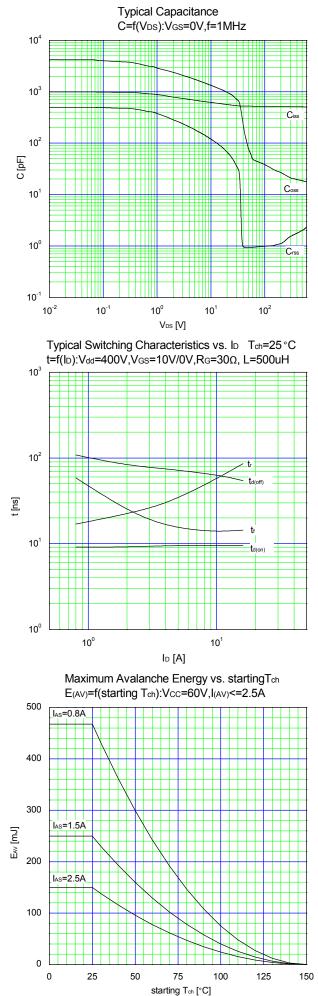
Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	Rth(ch-c)	-	-	1.79	°C/W
Channel to Ambient	R <sub>th(ch-a)</sub>	-	-	62	°C/W

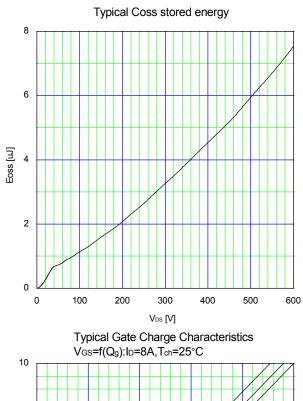


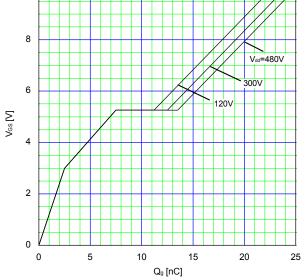




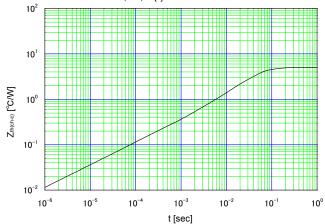
VSD [V]







 $\begin{array}{l} \mbox{Transient Thermal Impedance} \\ Z_{th(ch-c)} \mbox{=} f(t) \mbox{:} D \mbox{=} 0 \end{array}$ 



5

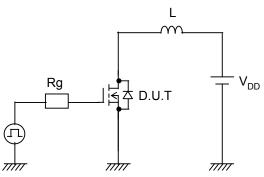


Fig.1 Avalanche Test circuit

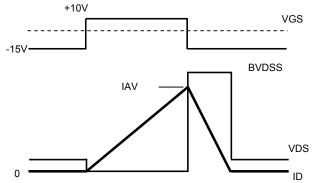
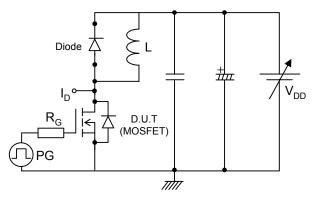


Fig.2 Operating waveforms of Avalanche Test





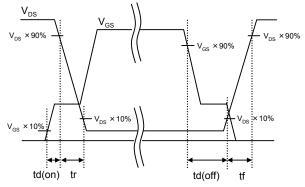


Fig.4 Operating waveform of Switching Test

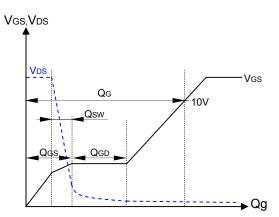


Fig.5 Operating waveform of Gate charge Test

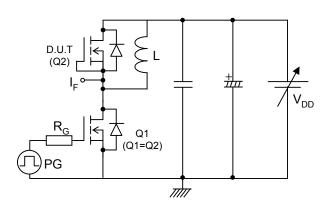


Fig.6 Reverse recovery Test circuit

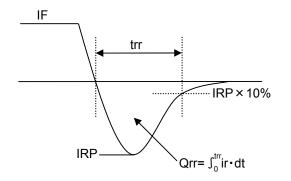
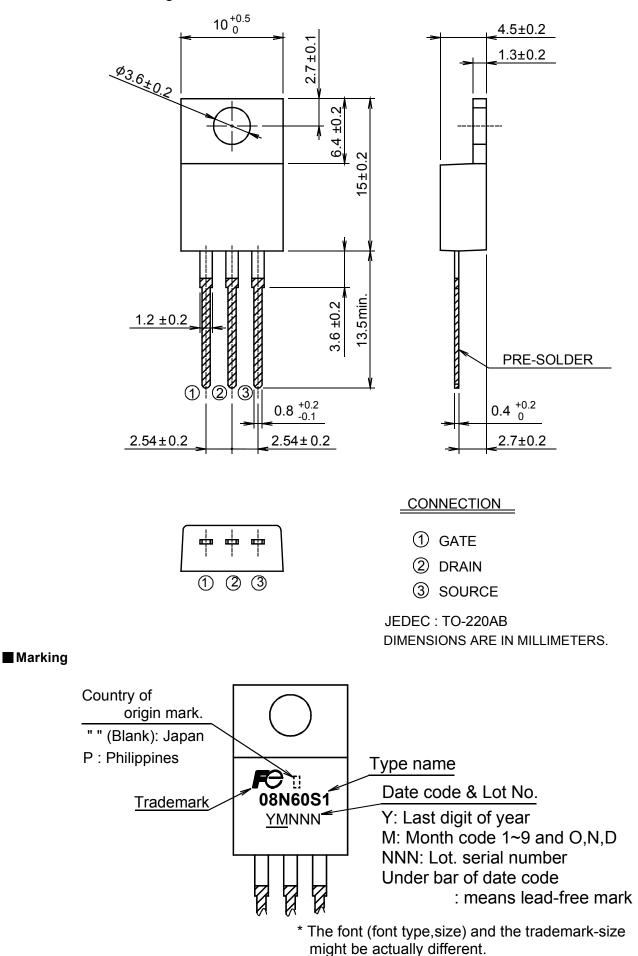


Fig.7 Operating waveform of Reverse recovery Test

### Outview: TO-220 Package



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